

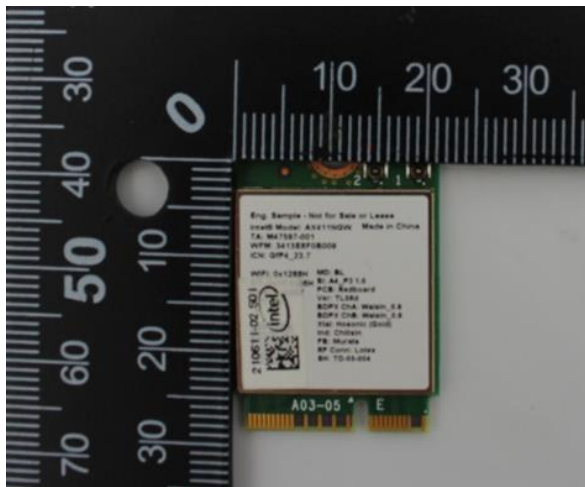
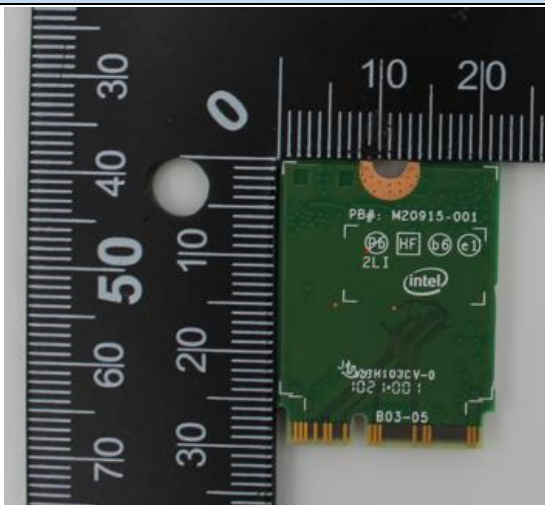
Annex D. Photographs

D.1 Test Setup

Conducted Test Setup

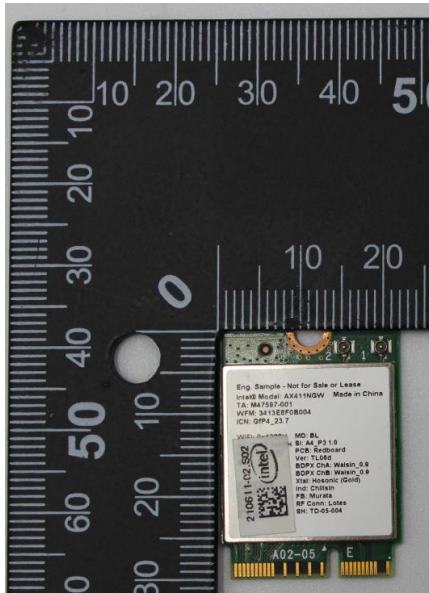


D.2 Test Sample

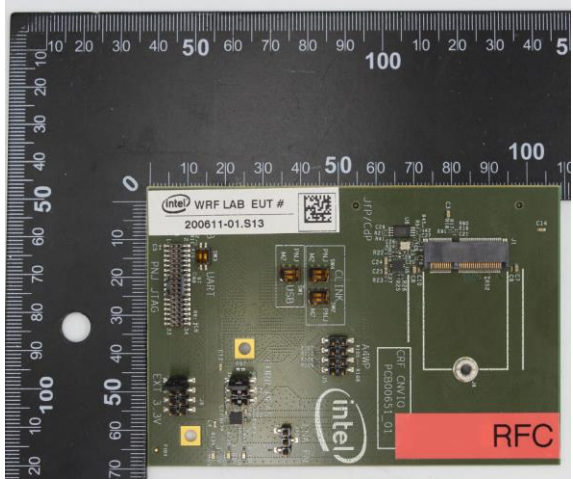
Sample #01	
Module Front	Module Back
 Front view of the module. The white label contains the following text: "King Sample - Not for Sale or Lease", "Intel Model: A521100N", "Made in China", "TA: M21551-001", "WTR: 541555F08008", "ICN: GMP4_23.7", "MPF: 041280N", "MD: BL", "Rev: A4 P3 1.6", "PCB: Redwood", "Ver: 7.1.004", "BOP2 CIA: March 0.8", "BOP2 CIA: March 0.8", "Rev: Redwood (B08)", "Int: China", "FB: Murena", "MP: Green, Luma", "BIC: TD-03-004". The label also features the Intel logo and a QR code. The module is marked "A03-05 E" at the bottom.	 Back view of the module. The green PCB features the following markings: "PB#: M20915-001", "2LI", "intel", "BOP2H103CV-0", "102 1-00 1", and "B03-05".
Extender board	Laptop
 Front view of the extender board. The green PCB is populated with various components, including a large black heat sink, a silver heat sink, and several integrated circuits. A ruler is placed above the board for scale.	 A Dell laptop with the module installed. The laptop is open, showing the screen and keyboard. The module is visible on the left side of the laptop.

Sample #02

Module Front

[Module Back](#)

Extender board



Laptop



End of the report

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